



High power cycling capability  
Low on-state and switching losses  
Designed for traction and industrial applications

## Phase Control Thyristor Type T393-2500-52

Mean on-state current		$I_{TAV}$	2500 A	
Repetitive peak off-state voltage		$V_{DRM}$	4600 ÷ 5200 V	
Repetitive peak reverse voltage		$V_{RRM}$		
Turn-off time		$t_q$	800 $\mu$ s	
$V_{DRM}, V_{RRM}, V$	4600	4800	5000	5200
Voltage code	46	48	50	52
$T_j, ^\circ C$	- 60 ÷ 125			

### MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
<b>ON-STATE</b>				
$I_{TAV}$	Mean on-state current	A	2500 3600	$T_c = 94^\circ C$ , Double side cooled $T_c = 70^\circ C$ , Double side cooled 180° half-sine wave; 50 Hz
$I_{TRMS}$	RMS on-state current	A	3925	$T_c = 94^\circ C$ , Double side cooled 180° half-sine wave; 50 Hz
$I_{TSM}$	Surge on-state current	kA	55.0 63.0	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			58.0 67.0	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
$I^2t$	Safety factor	$A^2s \cdot 10^3$	15100 19800	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 10$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
			13900 18600	$T_j = T_{jmax}$ $T_j = 25^\circ C$ 180° half-sine wave; $t_p = 8.3$ ms; single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50$ $\mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s
<b>BLOCKING</b>				
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	4600÷5200	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; 50 Hz; Gate open
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	4700÷5300	$T_{jmin} < T_j < T_{jmax}$ ; 180° half-sine wave; single pulse; Gate open
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	$0.6 \cdot V_{DRM}$ $0.6 \cdot V_{RRM}$	$T_j = T_{jmax}$ ; Gate open

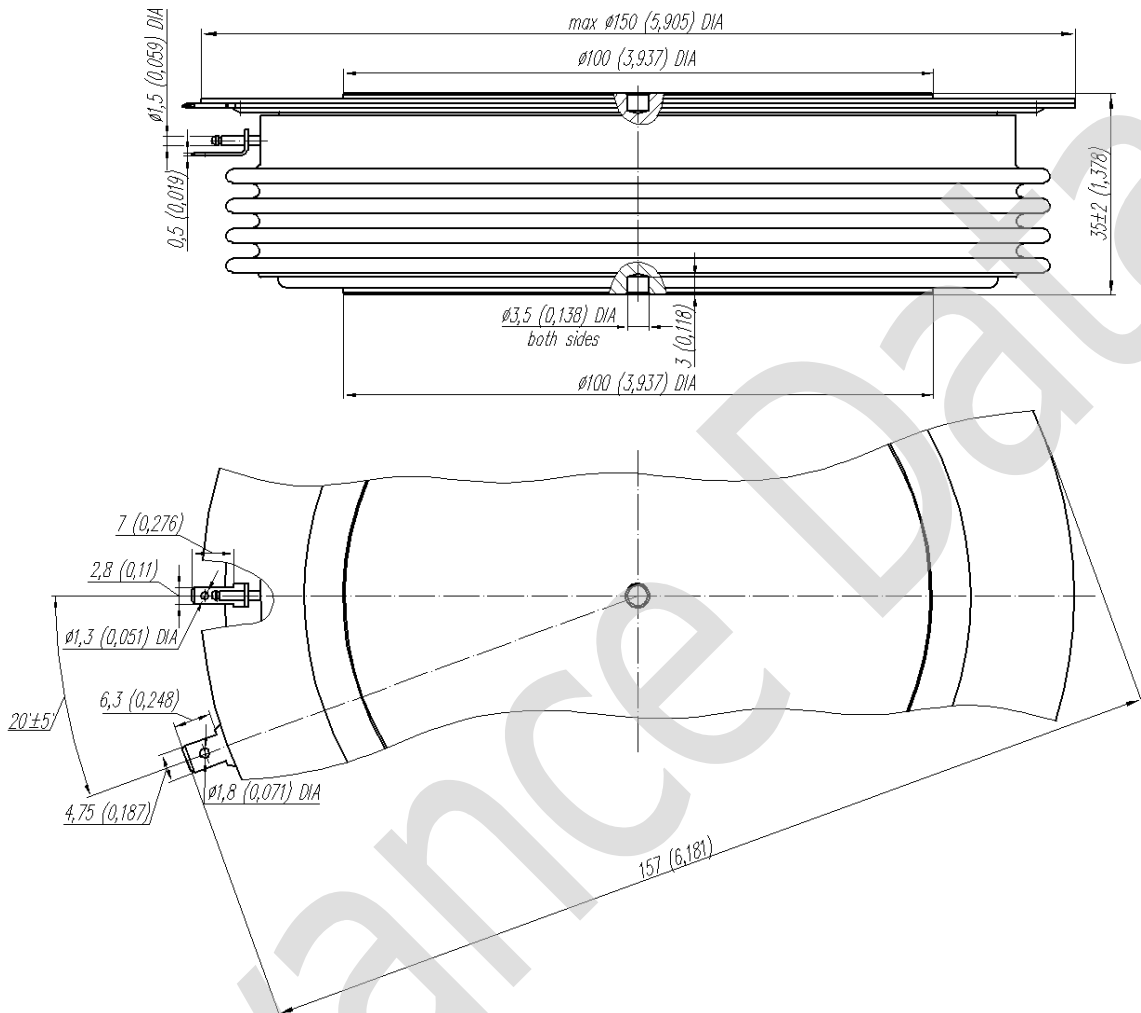
TRIGGERING				
$I_{FGM}$	Peak forward gate current	A	12	$T_j = T_{j\max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	5	$T_j = T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ( $f=1$ Hz)	A/ $\mu$ s	1000	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 2 I_{TAV}$ ; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 2$ A/ $\mu$ s
THERMAL				
$T_{stg}$	Storage temperature	$^{\circ}$ C	-60 ÷ 50	
$T_j$	Operating junction temperature	$^{\circ}$ C	-60 ÷ 125	
MECHANICAL				
F	Mounting force	kN	70.0 ÷ 90.0	
a	Acceleration	m/s <sup>2</sup>	50	Device clamped

## CHARACTERISTICS

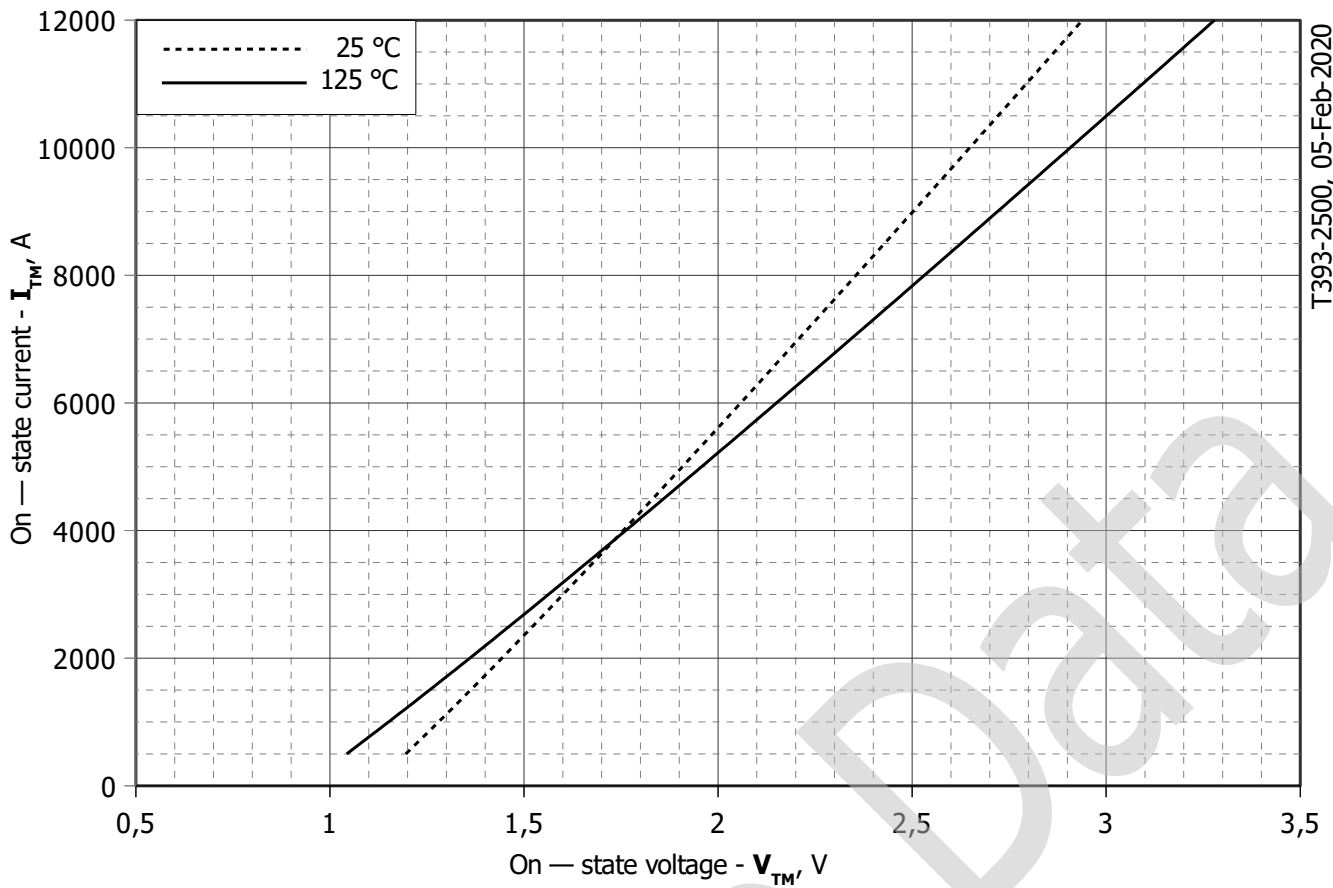
Symbols and parameters		Units	Values	Conditions	
ON-STATE					
$V_{TM}$	Peak on-state voltage, max	V	2.10	$T_j = 25 \text{ }^{\circ}\text{C}$ ; $I_{TM} = 6300$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.00	$T_j = T_{j\max}$ ;	
$r_T$	On-state slope resistance, max	m $\Omega$	0.190	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
$I_L$	Latching current, max	mA	1500	$T_j = 25 \text{ }^{\circ}\text{C}$ ; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ $\mu$ s	
$I_H$	Holding current, max	mA	300	$T_j = 25 \text{ }^{\circ}\text{C}$ ; $V_D = 12$ V; Gate open	
BLOCKING					
$I_{DRM}$ , $I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	300	$T_j = T_{j\max}$ ; $V_D = V_{DRM}$ ; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	500, 1000, 1600	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; Gate open	
TRIGGERING					
$V_{GT}$	Gate trigger direct voltage, max	V	5.00	$T_j = T_{j\min}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
			3.00	$T_j = 25 \text{ }^{\circ}\text{C}$	
$I_{GT}$	Gate trigger direct current, max	mA	2.00	$T_j = T_{j\max}$	
			500	$T_j = T_{j\min}$	
			300	$T_j = 25 \text{ }^{\circ}\text{C}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	200	$T_j = T_{j\max}$	
			0.35	$T_j = T_{j\max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ;	
$I_{GD}$	Gate non-trigger direct current, min	mA	15.00	Direct gate current	
SWITCHING					
$t_{gd}$	Delay time	$\mu$ s	4.00	$T_j = 25 \text{ }^{\circ}\text{C}$ ; $V_D = 1500$ V; $I_{TM} = I_{TAV}$ ; $di/dt = 200$ A/ $\mu$ s; Gate pulse: $I_G = 2$ A; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 2$ A/ $\mu$ s	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	800	$dv_D/dt = 50$ V/ $\mu$ s; $T_j = T_{j\max}$ ; $I_{TM} = 1000$ A; $di_R/dt = -5$ A/ $\mu$ s; $V_R = 100$ V; $V_D = 1600$ V;	
$Q_{rr}$	Total recovered charge, max	$\mu$ C	12500	$T_j = T_{j\max}$ ; $I_{TM} = 1000$ A;	
$t_{rr}$	Reverse recovery time, typ	$\mu$ s	157	$di_R/dt = -5$ A/ $\mu$ s;	
$I_{rrM}$	Peak reverse recovery current, max	A	159	$V_R = 100$ V	

THERMAL					
$R_{thjc}$	Thermal resistance, junction to case, max	°C/W	0.0057	Direct current	Double side cooled
$R_{thjc-A}$			0.0125		Anode side cooled
$R_{thjc-K}$			0.0103		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	°C/W	0.0010	Direct current	
MECHANICAL					
w	Weight, max	g	2700		
$D_s$	Surface creepage distance	mm (inch)	62.09 (2.444)		
$D_a$	Air strike distance	mm (inch)	23.40 (0.921)		

PART NUMBERING GUIDE							NOTES										
T	393	2500	52	A2	B2	N	1) Critical rate of rise of off-state voltage <table border="1"> <thead> <tr> <th>Symbol of Group</th> <th>E2</th> <th>A2</th> <th>T1</th> </tr> </thead> <tbody> <tr> <td><math>(dv_D/dt)_{crit}, V/\mu s</math></td> <td>500</td> <td>1000</td> <td>1600</td> </tr> </tbody> </table>			Symbol of Group	E2	A2	T1	$(dv_D/dt)_{crit}, V/\mu s$	500	1000	1600
Symbol of Group	E2	A2	T1														
$(dv_D/dt)_{crit}, V/\mu s$	500	1000	1600														
1	2	3	4	5	6	7											
1. Phase Control Thyristor 2. Design version 3. Mean on-state current, A 4. Voltage code 5. Critical rate of rise of off-state voltage, V/ $\mu s$ 6. Turn-off time ( $dv_D/dt=50 V/\mu s$ ) 7. Ambient conditions: N – normal; T – tropical							2) Turn-off time ( $dv_D/dt=50 V/\mu s$ ) <table border="1"> <thead> <tr> <th>Symbol of Group</th> <th>B2</th> </tr> </thead> <tbody> <tr> <td><math>t_{tr}, \mu s</math></td> <td>800</td> </tr> </tbody> </table>			Symbol of Group	B2	$t_{tr}, \mu s$	800				
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All dimensions in millimeters (inches)



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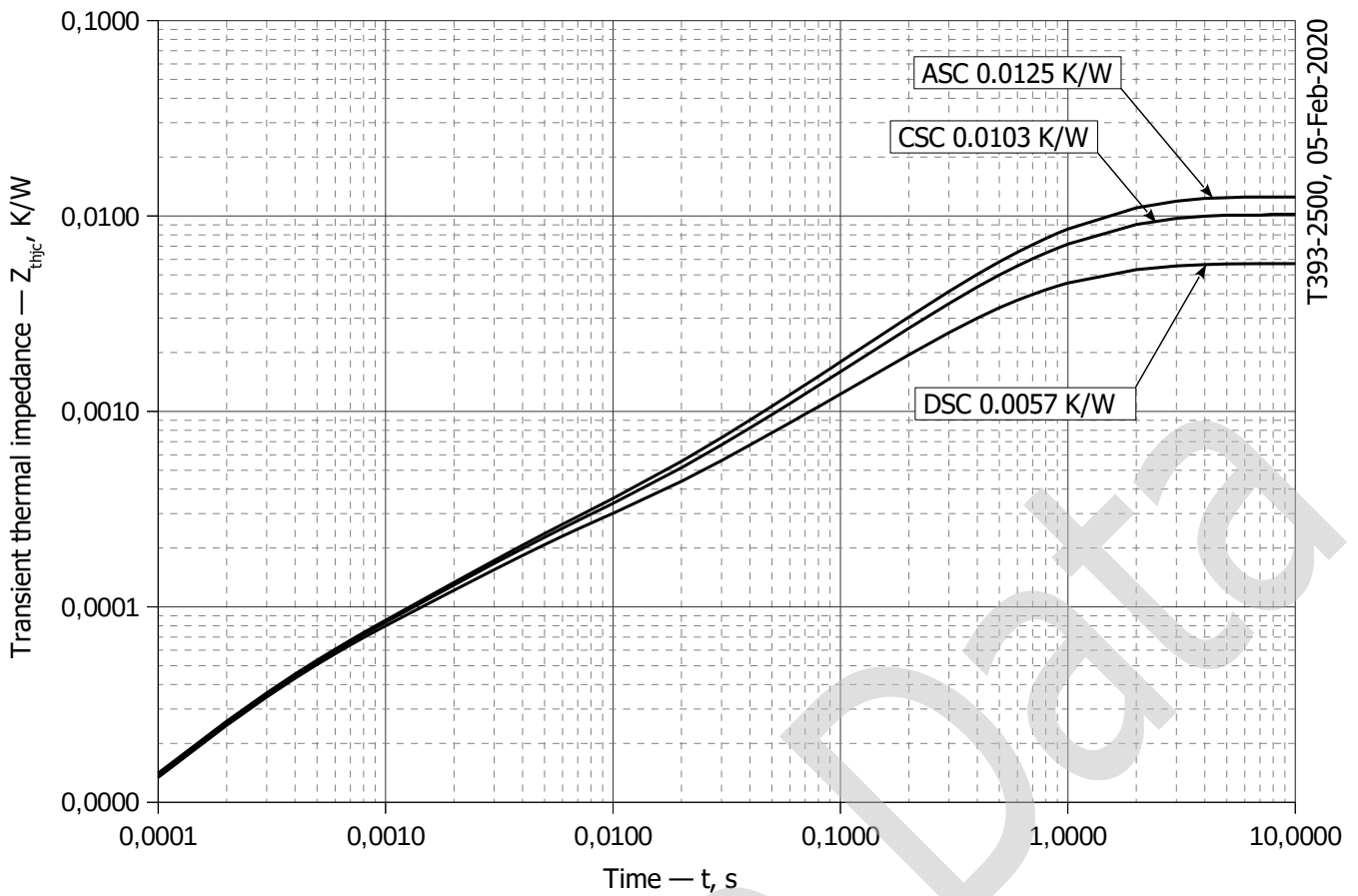
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j,max}$
<b>A</b>	1.17300000	1.04510000
<b>B</b>	0.00012979	0.00016438
<b>C</b>	-0.01979700	-0.03193100
<b>D</b>	0.00360030	0.00512580

**On-state characteristic model (see Fig. 1)**



T393-2500, 05-Feb-2020

**Fig 2 – Transient thermal impedance  $Z_{thjc}$  vs. time  $t$**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

$i$	1	2	3	4	5	6
$R_i$ , K/W	0.002457	-0.003548	0.002909	0.0002069	3.51e-005	0.00364
$\tau_i$ , s	1.062	0.005022	0.3787	0.0257	0.0003732	0.004916

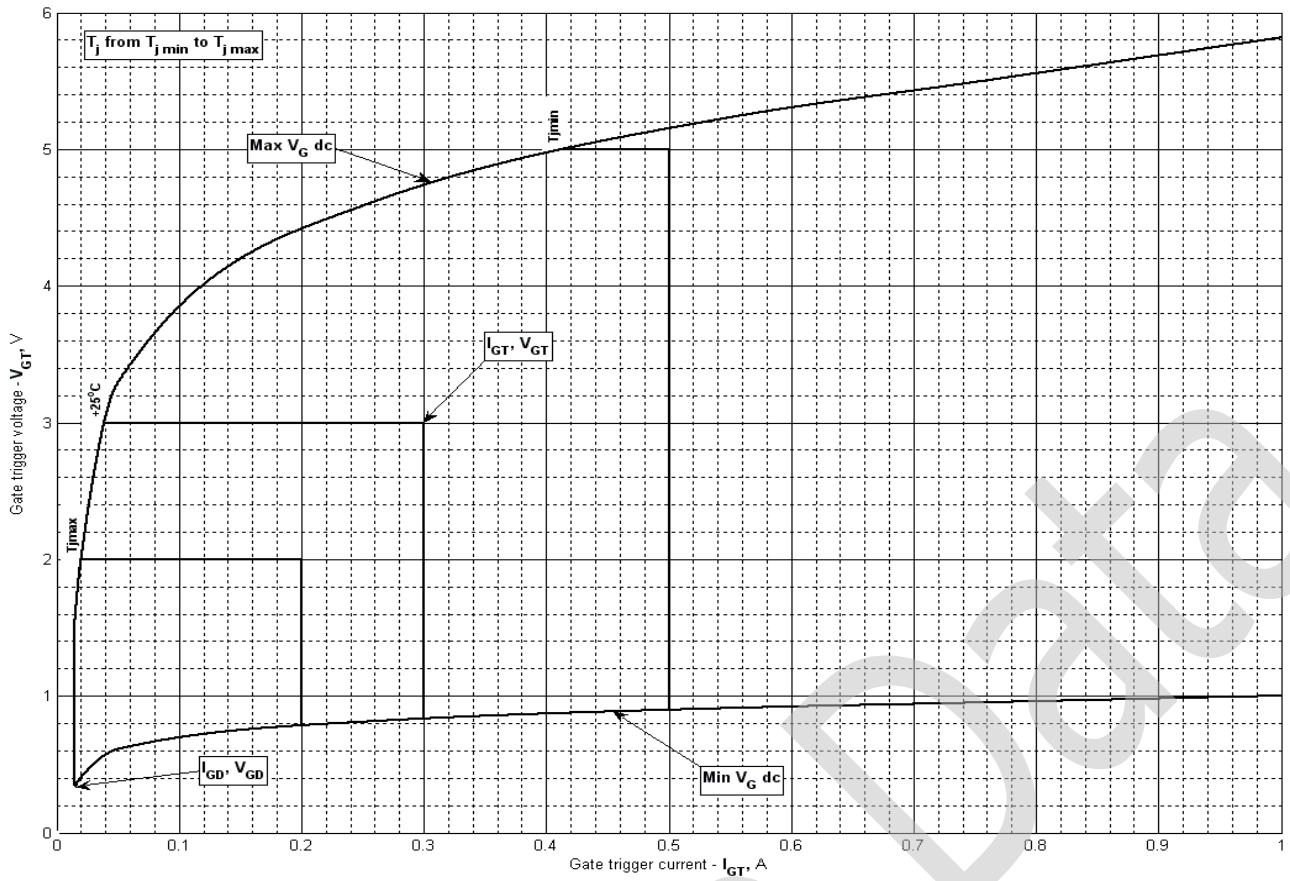
DC Anode side cooled

$i$	1	2	3	4	5	6
$R_i$ , K/W	0.006812	0.002637	0.002729	0.0001806	0.000122	3.069e-005
$\tau_i$ , s	1.06	1.131	0.3835	0.02886	0.003033	0.0003349

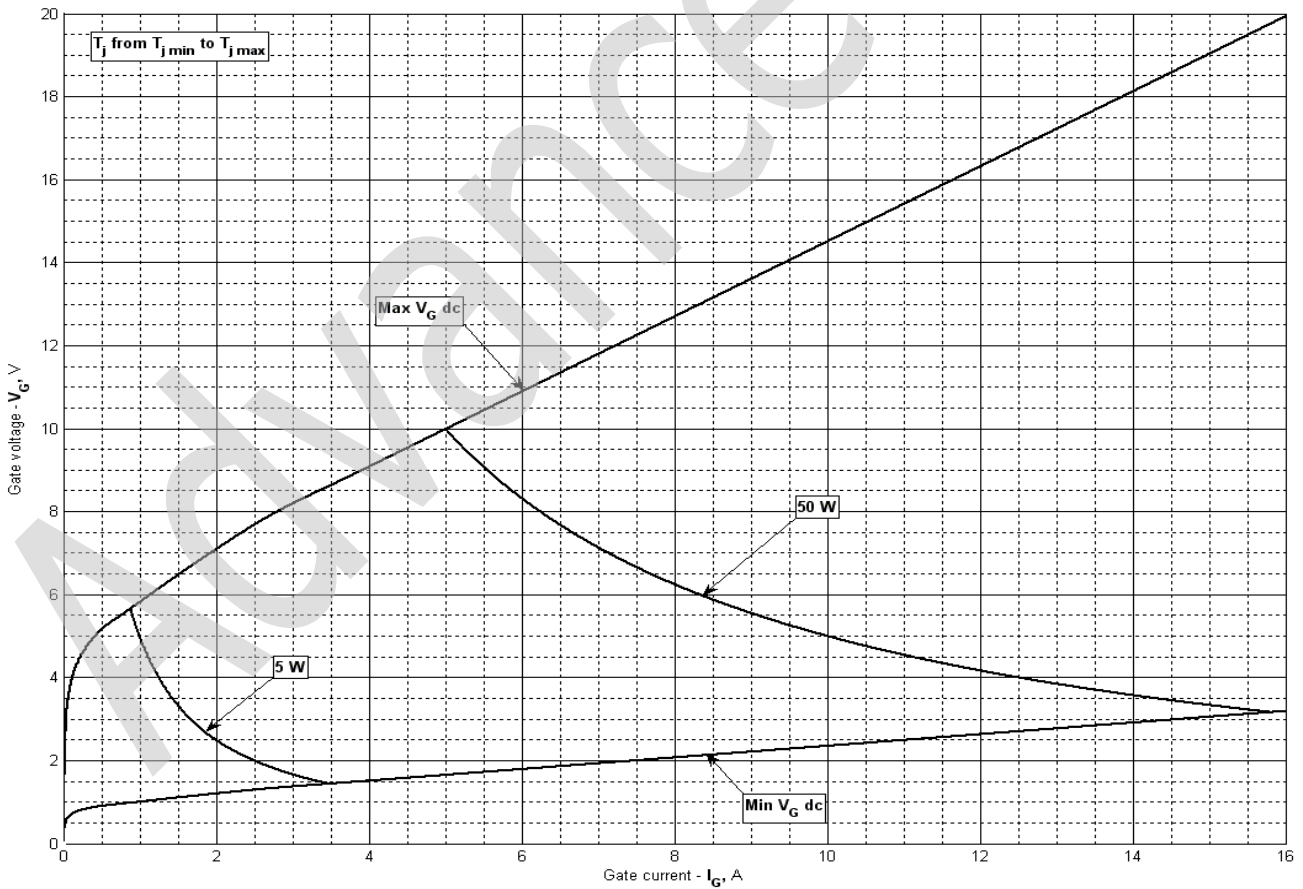
DC Cathode side cooled

$i$	1	2	3	4	5	6
$R_i$ , K/W	0.004458	0.002601	0.002763	0.0001806	0.0001224	3.094e-005
$\tau_i$ , s	1.06	1.100	0.3794	0.0291	0.003057	0.0003374

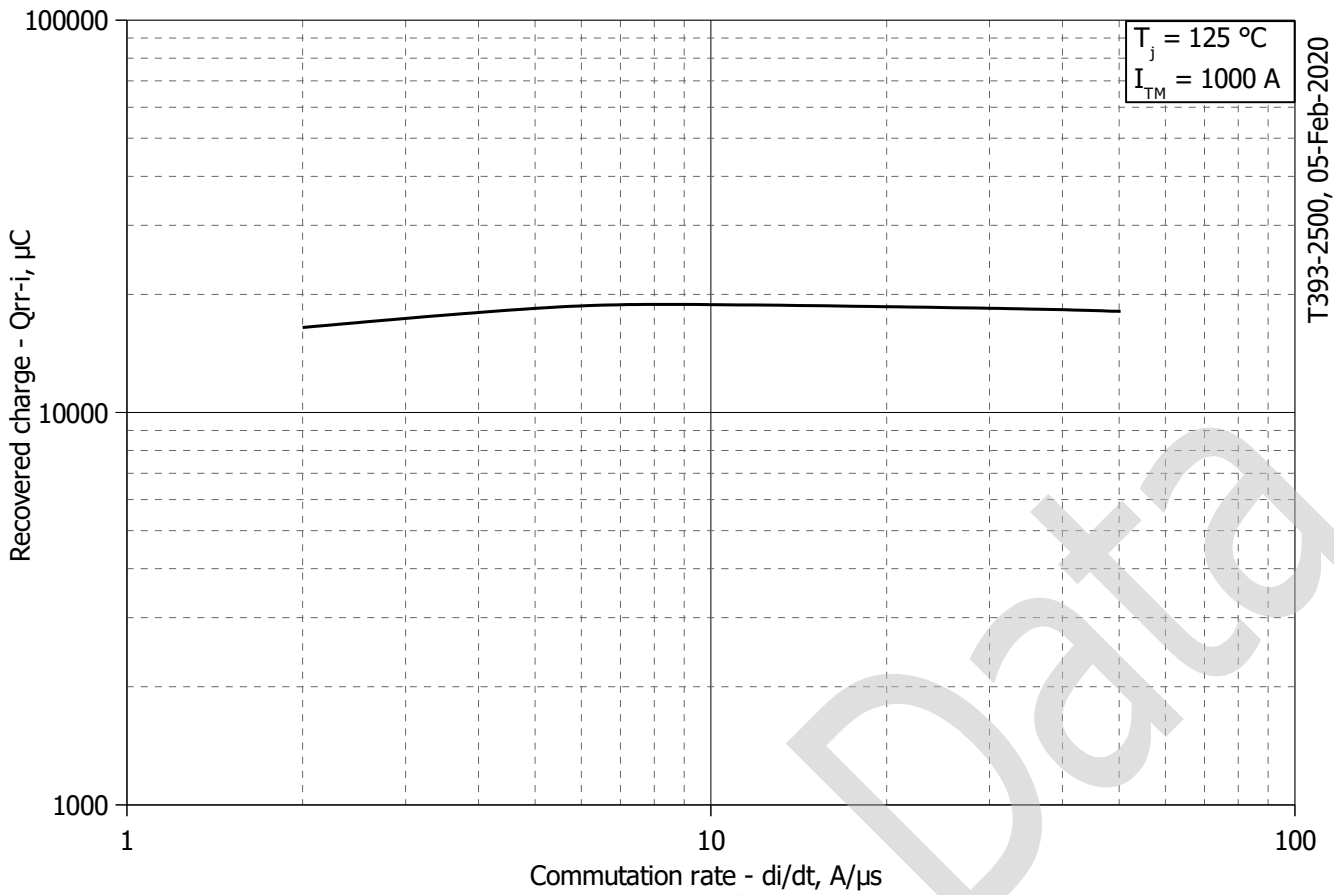
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**



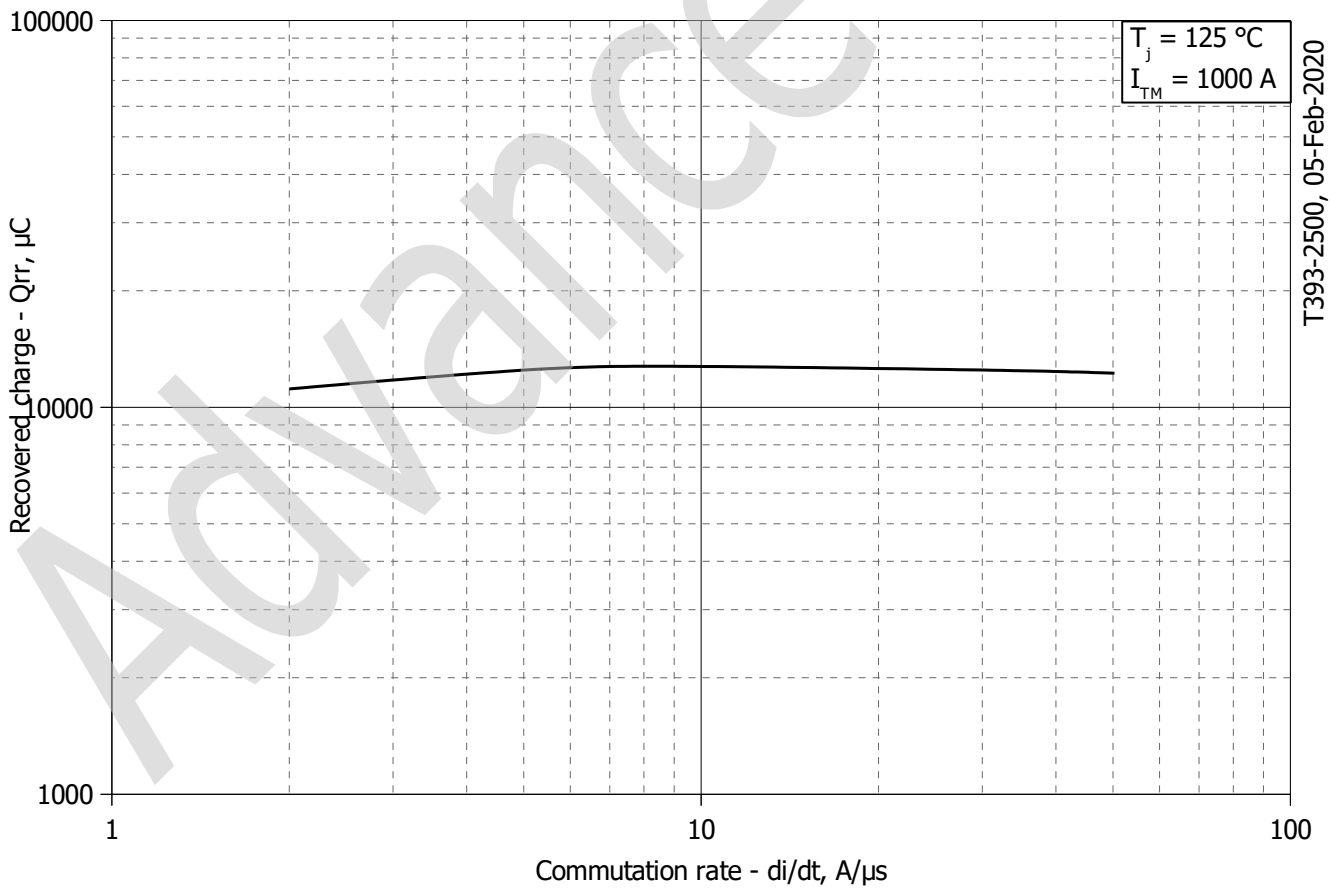
**Fig 3 – Gate characteristics – Trigger limits**



**Fig 4 - Gate characteristics – Power curves**

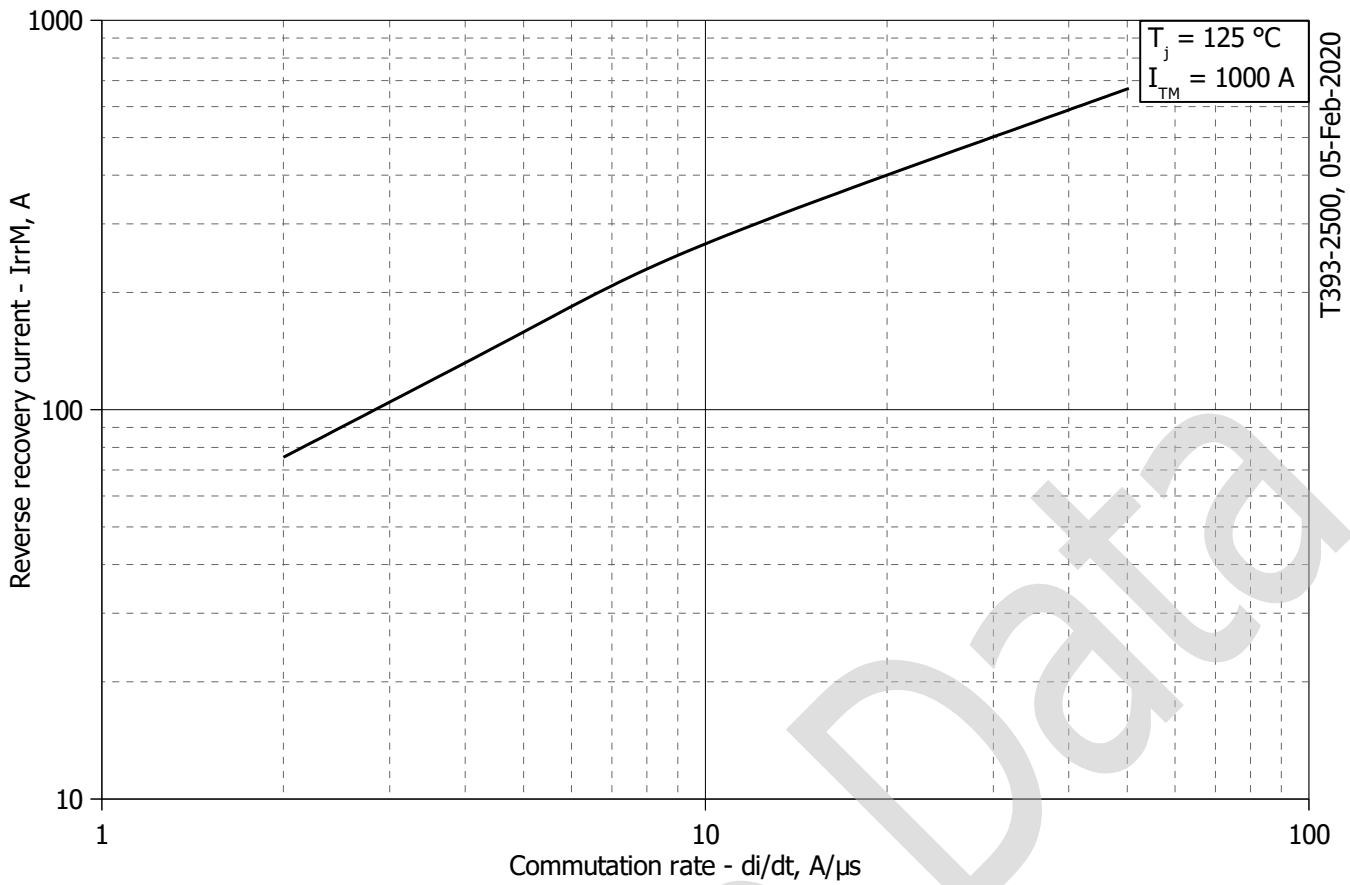


**Fig 5 – Maximum recovered charge  $Q_{rr-i}$  (integral) vs. commutation rate  $di_R/dt$**

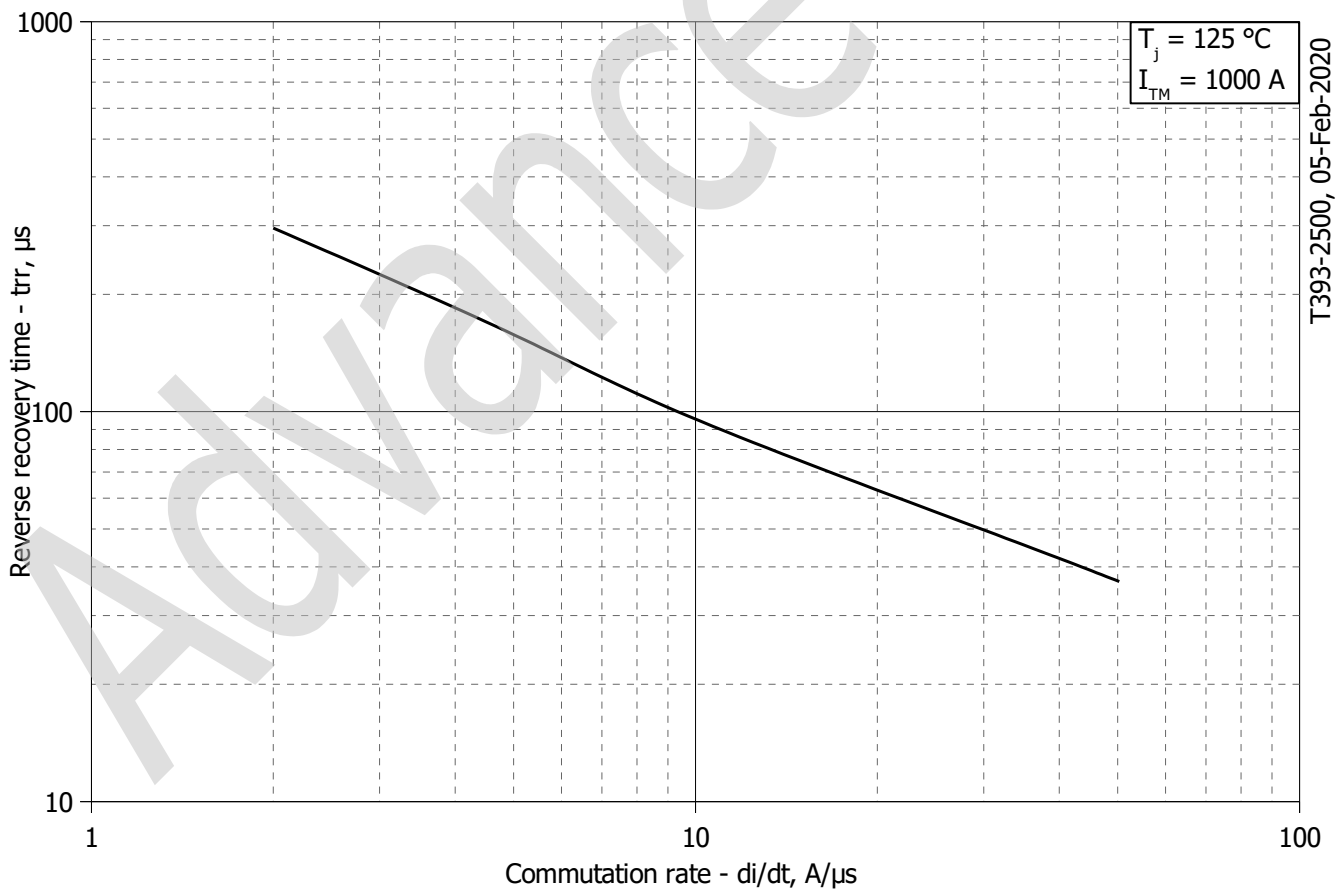


**Fig 6 – Maximum recovered charge  $Q_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**

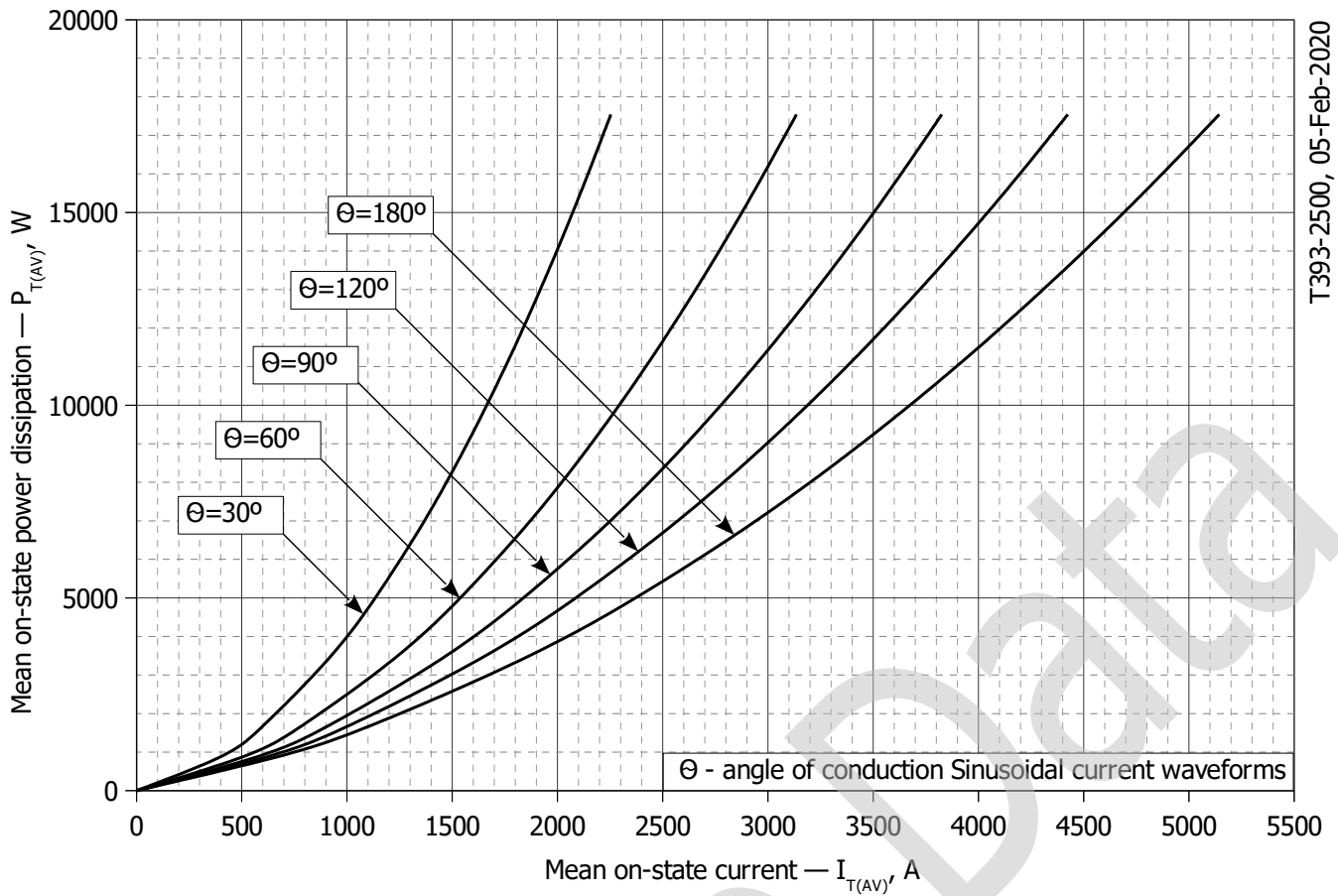




**Fig 7 – Maximum reverse recovery current  $I_{rrM}$  vs. commutation rate  $di_r/dt$**

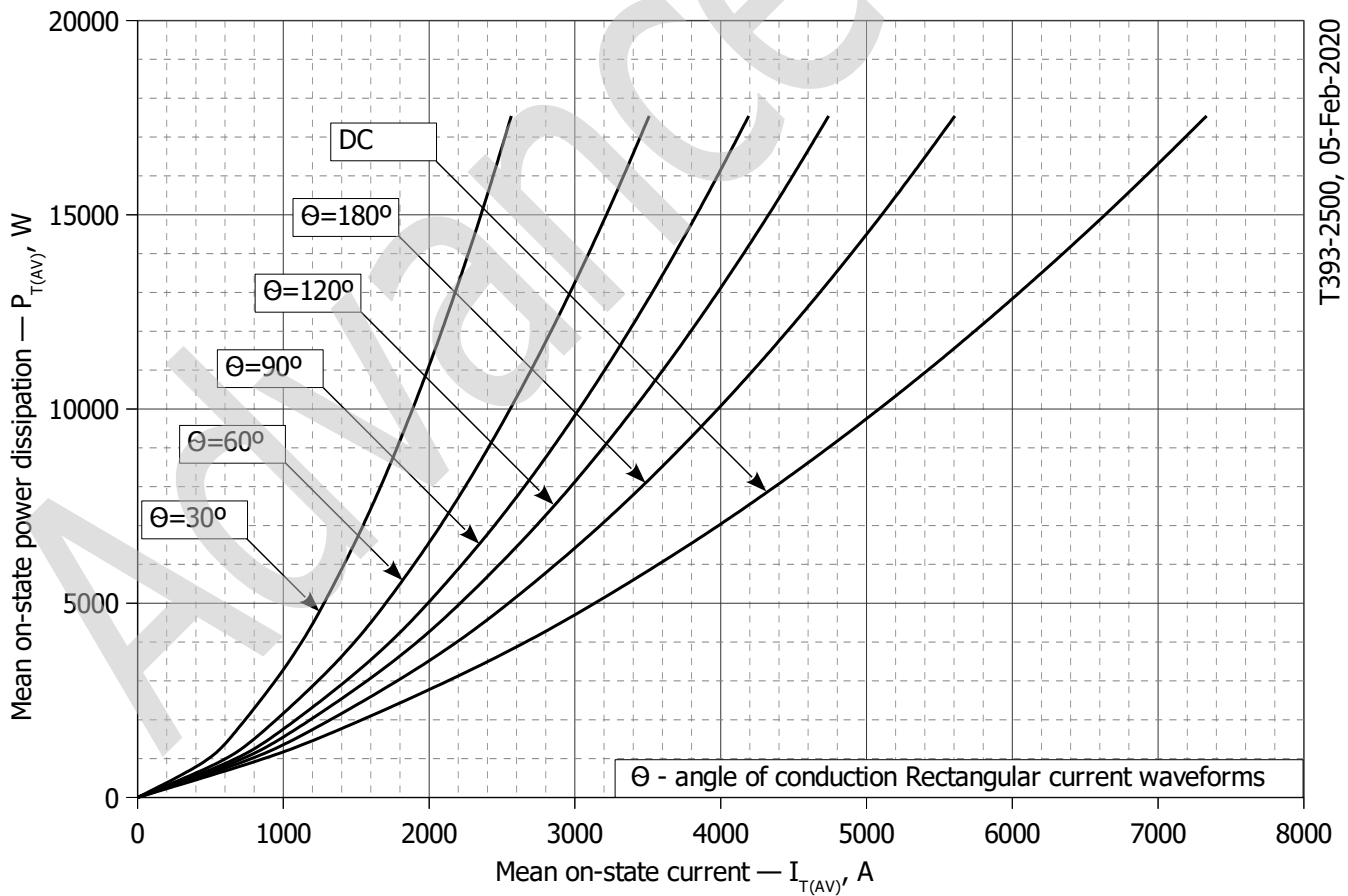


**Fig 8 – Maximum recovery time  $t_{rr}$  vs. commutation rate  $di_r/dt$  (25% chord)**



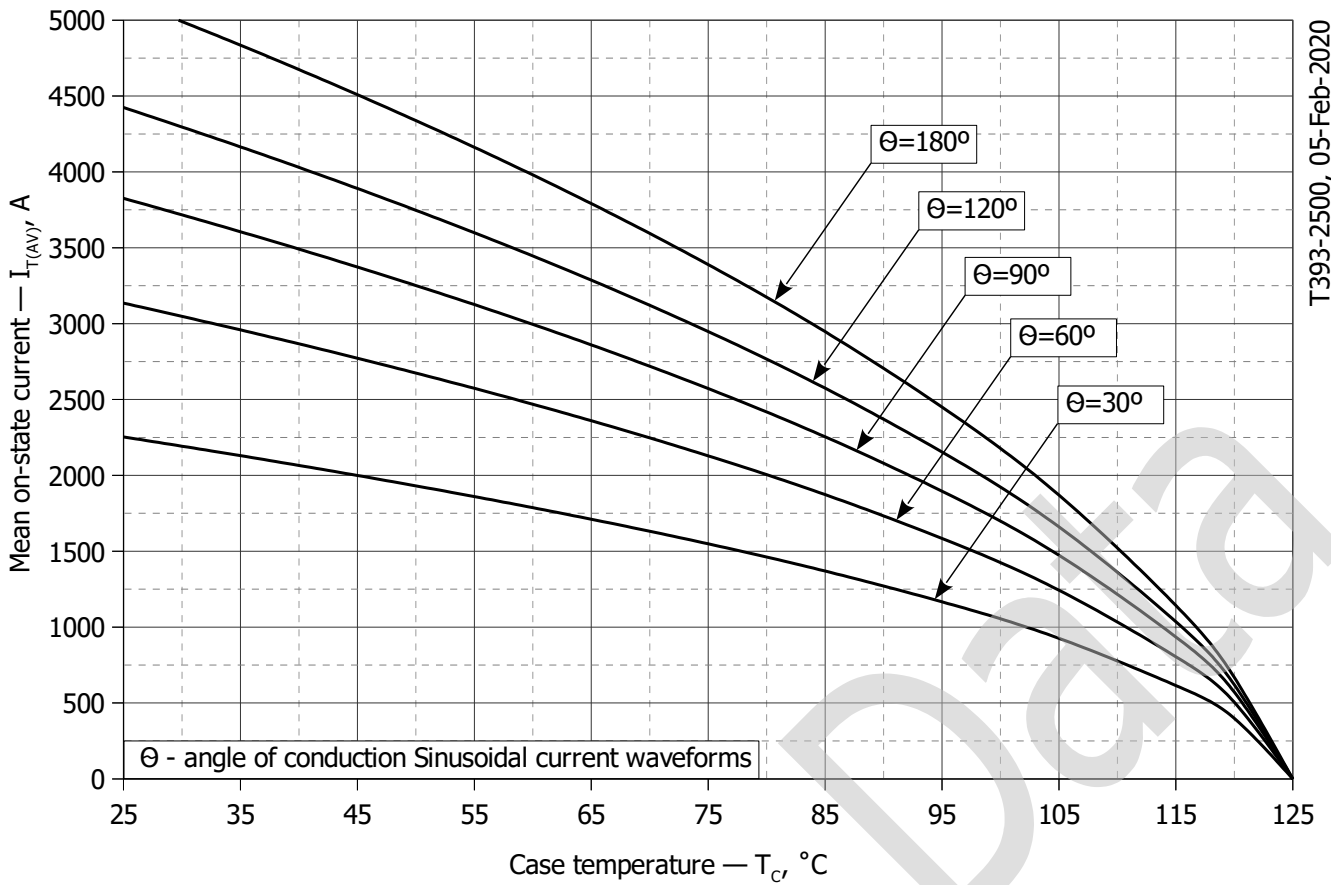
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**Fig. 9 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for sinusoidal current waveforms at different conduction angles ( $f=50\text{Hz}$ , DSC)**

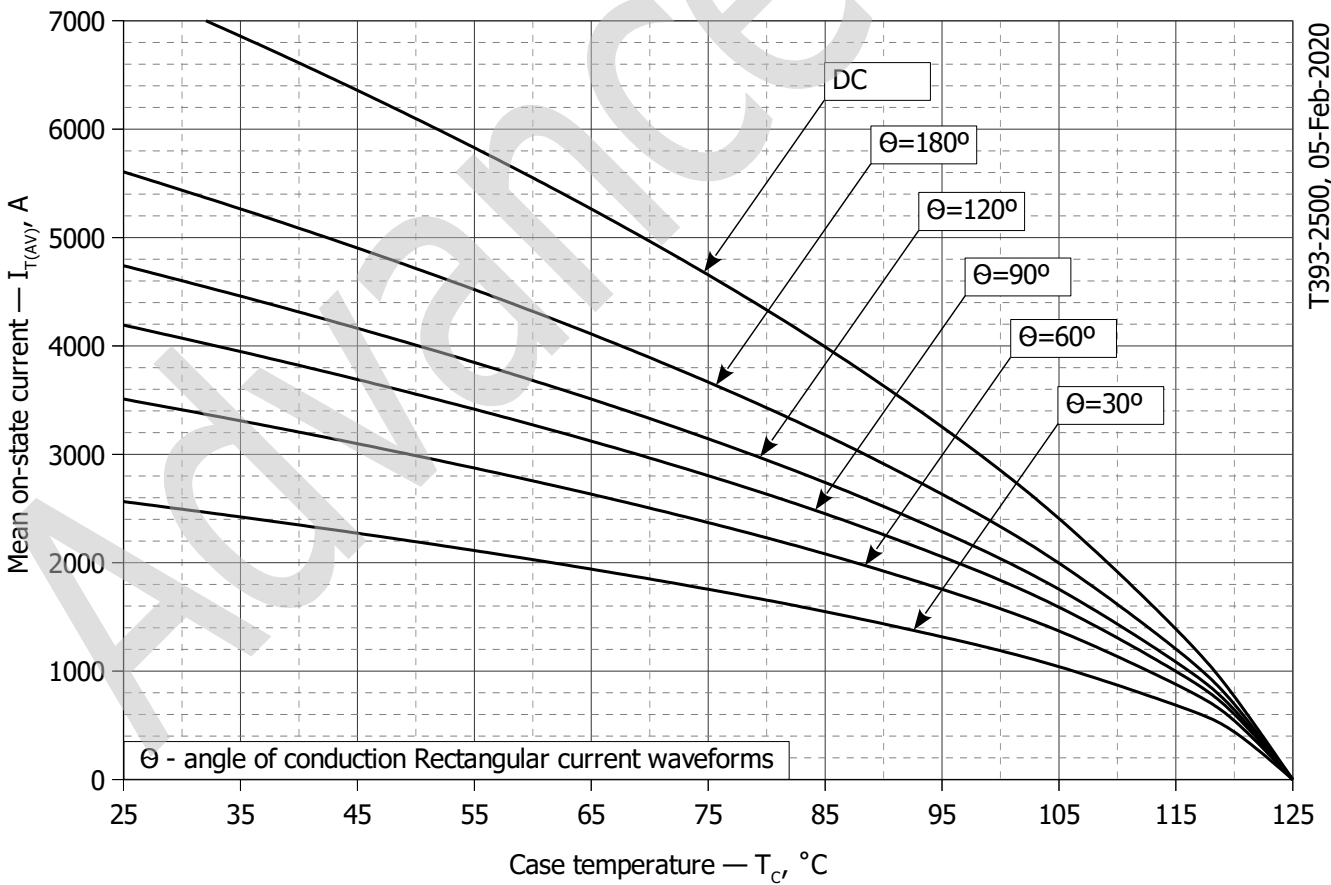


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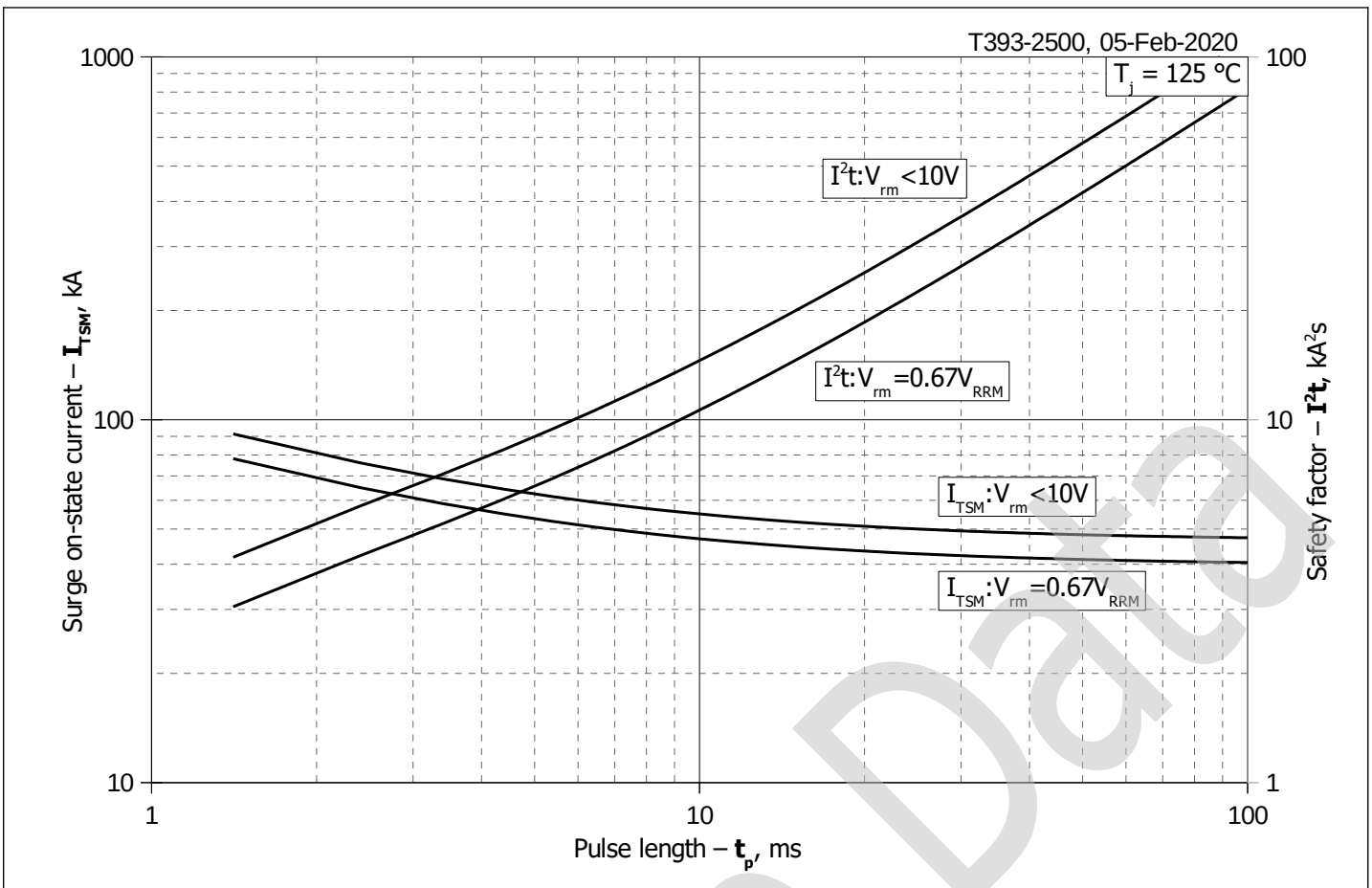
**Fig. 10 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for rectangular current waveforms at different conduction angles and for DC ( $f=50\text{Hz}$ , DSC)**



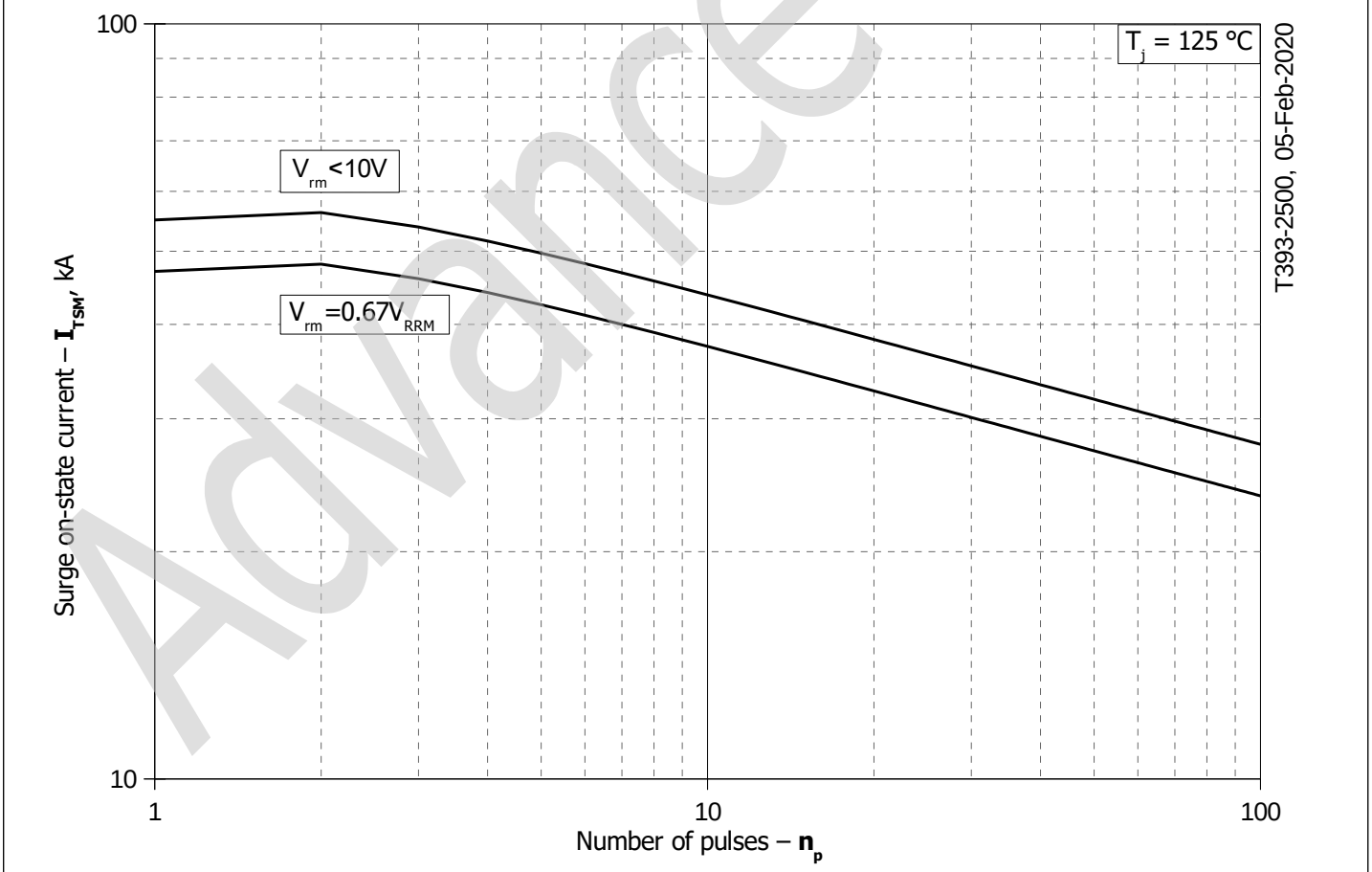
**Fig. 11 – Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for sinusoidal current waveforms at different conduction angles ( $f=50Hz$ , DSC)**



**Fig. 12 - Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for rectangular current waveforms at different conduction angles and for DC ( $f=50Hz$ , DSC)**



**Fig. 13 – Maximum surge on-state current  $I_{TSM}$  and safety factor  $I^2t$  vs. pulse length  $t_p$**



**Fig. 14 - Maximum surge on-state current  $I_{TSM}$  vs. number of pulses  $n_p$**